

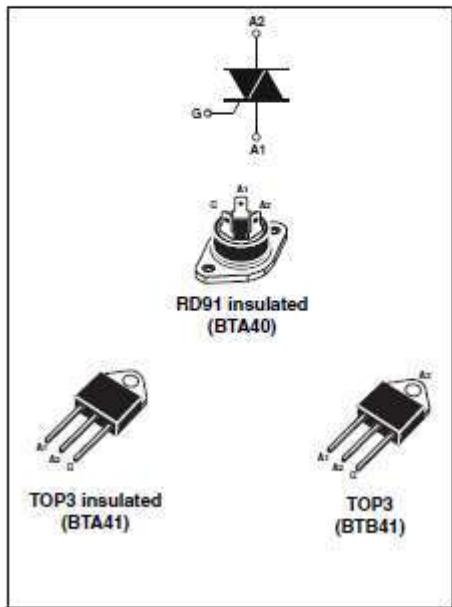
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симистор, тиристор, **каталог, описание, технические, характеристики, datasheet, параметры, маркировка, габариты, фото, даташит,**

BTA40, BTA41, BTB41

40 A standard TRIACs



QR код

ЭЛЕКТРОННЫЕ КОМПОНЕНТЫ

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Даташиты , Симисторы серии BTA40, BTA41, BTB41

Симисторы серии BTA40, BTA41, BTB41

Апрель 17, 2017

Свойства

Мощные симисторы

Низкое тепловое сопротивление

Высокая коммутирующая способность

Сертифицированы по стандарту UL1557

Корпусы соответствуют директиве RoHS (2002/95/EC)

Применение

В качестве ключа в релейных схемах, для регулировки нагрева, в цепях запуска асинхронных электродвигателей

Для управления фазой в димерах света, в регуляторах частоты вращения коллекторных двигателей

Описание

Доступны в мощных корпусах. Симисторы серии ВТА / ВТВ40-41 подходят для коммутации переменного тока общего назначения. Серия ВТА снабжена изолированным язычком (номинальное среднеквадратичное напряжение пробоя 2500 В).

Типы корпусов (A1, A2 - аноды, G - управляющий электрод)

Типы корпусов (A1, A2 — аноды, G — управляющий электрод)

Общие характеристики

Обозначение

IT(RMS)

VDRM/VRRM

!gt

Абсолютные максимальные значения

RD91 / TOP ins.

ITSM

F = 60 Гц

I2t

dI/dt

VDSM/VRSM

IGM

PG(AV)

Tstg

Tj

Электрические характеристики (Tj = 25 °C)

IGT(1)

IV

VGT

VGD

IH (2)

IL

II

dV/dt(2)

(dV/dt)c(2)

Минимум IGT гарантируется на уровне 5% от IGT max.

Для обеих полярностей от A2 к A1.

Статические характеристики

VT(1)

Vt0(2)

Rd(2)

IDRM

IRRM

Тепловое сопротивление

Rth(j-c)

TOP3

Rth(j-a)

Зависимость максимальной рассеиваемой мощности от действующего тока (полный цикл)

Зависимость действующего тока от температуры корпуса

Зависимость теплового сопротивления от длительности импульса

Характеристики в открытом состоянии (максимальные значения)

Зависимость ударного тока в открытом состоянии от количества циклов

Зависимость ударного тока в открытом состоянии от синусоидального импульса и значения плавления

Зависимость ударного тока в открытом состоянии от синусоидального импульса и значения плавления
Относительное изменение отпирающего тока, тока удержания и тока включения в зависимости от температуры перехода

Относительное изменение критической скорости снижения основного тока в зависимости от критической скорости нарастания напряжения

Относительное изменение критической скорости снижения основного тока в зависимости от температуры перехода

Расшифровка серии

Размеры для корпуса TOP3

Размеры для корпуса RD91

bta40-600b (st)

bta40-800b (st)

bta40-700b (st)

bta40-800brg (st)

bta40-800bw (st)

bta41-600brg (st)

bta41-800brg (st)

bta41-700brg (st)

bta41-600b (st)

bta412y-600b.127 (ween/nxp)

bta412y-600c.127 (ween/nxp)

bta412y-800b.127 (ween/nxp)

bta412y-800c.127 (ween/nxp)

bta416y-600b.127 (ween/nxp)

bta416y-600c.127 (ween/nxp)

bta416y-800b.127 (ween/nxp)

bta416y-800c.127 (ween/nxp)

bta410y-600ct.127 (ween/nxp)

bta410y-600et.127 (ween/nxp)

bta410y-800bt.127 (ween/nxp)

bta410y-800ct.127 (ween/nxp)

bta41-800bq (ween/nxp)

bta410-600et127 (ween/nxp)

bta410-800ct127 (ween/nxp)

bta410x-600ct127 (ween/nxp)

bta410y-600ct127 (ween/nxp)

bta410y-600et127 (ween/nxp)

bta410x-800bt127 (ween/nxp)

bta410y-600ct (ween/nxp)

bta41-800b (st)

bta412y-600c (nxp)

bta412y-800c (nxp)

bta412y-800et (ween/nxp)

40 A standard TRIACs

Features

- High current TRIAC
- Low thermal resistance with clip bonding
- High commutation capability
- BTA series UL1557 certified (File ref: 81734)
- Packages are RoHS (2002/95/EC) compliant

Applications

- On/off function in static relays, heating regulation, induction motor starting circuits
- Phase control operations in light dimmers, motor speed controllers, and similar

Description

Available in high power packages, the BTA/BTB40-41 series is suitable for general purpose AC switching.

The BTA series provides an insulated tab (rated at 2500 V rms).

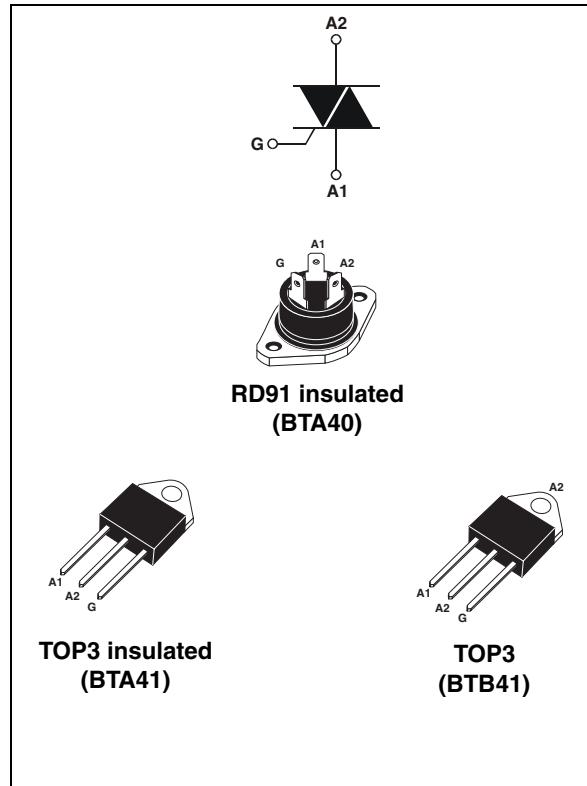


Table 1. Device summary

Symbol	Parameter	BTA40 ⁽¹⁾	BTA41 ⁽¹⁾	BTB41	Unit
I _{T(RMS)}	On-state rms current	40	41	41	A
V _{DRM/V_{RRM}}	Repetitive peak off-state voltage	600 and 800	600 and 800	600 and 800	V
I _{GT}	Triggering gate current	50	50	50	mA

1. Insulated package

1 Characteristics

Table 2. Absolute maximum ratings

Symbol	Parameter			Value	Unit
$I_{T(RMS)}$	On-state rms current (full sine wave)	TOP3	$T_c = 95^\circ C$	40	A
		RD91 / TOP ins.	$T_c = 80^\circ C$		
I_{TSM}	Non repetitive surge peak on-state current (full cycle, T_j initial = 25 °C)	F = 50 Hz	t = 20 ms	400	A
		F = 60 Hz	t = 16.7 ms	420	
I^2t	I^2t Value for fusing	$t_p = 10 \text{ ms}$		1000	A²s
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \leq 100 \text{ ns}$	F = 120 Hz	$T_j = 125^\circ C$	50	A/μs
V_{DSM}/V_{RSM}	Non repetitive surge peak off-state voltage	$t_p = 10 \text{ ms}$	$T_j = 25^\circ C$	$V_{DSM}/V_{RSM} + 100$	V
I_{GM}	Peak gate current	$t_p = 20 \mu\text{s}$	$T_j = 125^\circ C$	8	A
$P_{G(AV)}$	Average gate power dissipation		$T_j = 125^\circ C$	1	W
T_{stg} T_j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	°C

Table 3. Electrical characteristics ($T_j = 25^\circ C$, unless otherwise specified)

Symbol	Parameter			Value	Unit
$I_{GT}^{(1)}$	$V_D = 12 \text{ V}$ $R_L = 33 \Omega$	I - II - III	MAX.	50	mA
		IV		100	
V_{GT}		ALL	MAX.	1.3	V
V_{GD}	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ $T_j = 125^\circ C$	ALL	MIN.	0.2	V
$I_H^{(2)}$	$I_T = 500 \text{ mA}$		MAX.	80	mA
I_L	$I_G = 1.2 I_{GT}$	I - III - IV	MAX.	70	mA
		II		160	
$dV/dt^{(2)}$	$V_D = 67\% V_{DRM}$ gate open	$T_j = 125^\circ C$	MIN.	500	V/μs
$(dV/dt)c^{(2)}$	$(dI/dt)c = 20 \text{ A/ms}$	$T_j = 125^\circ C$	MIN.	10	V/μs

1. Minimum I_{GT} is guaranteed at 5% of I_{GT} max.

2. for both polarities of A2 referenced to A1

Table 4. Static characteristics

Symbol	Test conditions			Value	Unit
$V_T^{(1)}$	$I_{TM} = 60 \text{ A}$	$t_p = 380 \mu\text{s}$	$T_j = 25^\circ\text{C}$	MAX.	1.55 V
$V_{t0}^{(2)}$	Threshold voltage		$T_j = 125^\circ\text{C}$	MAX.	0.85 V
$R_d^{(2)}$	Dynamic resistance		$T_j = 125^\circ\text{C}$	MAX.	10 mΩ
I_{DRM} I_{RRM}	$V_{DRM} = V_{RRM}$		$T_j = 25^\circ\text{C}$	MAX.	5 μA
			$T_j = 125^\circ\text{C}$		5 mA

1. Minimum I_{GT} is guaranteed at 5% of I_{GT} max.

2. for both polarities of A2 referenced to A1

Table 5. Thermal resistance

Symbol	Test conditions		Value	Unit
$R_{th(j-c)}$	Junction to case (AC)	RD91 (insulated) / TOP3 insulated	0.9	°C/W
		TOP3	0.6	
$R_{th(j-a)}$	Junction to ambient	TOP3 / TOP3 insulated	50	°C/W

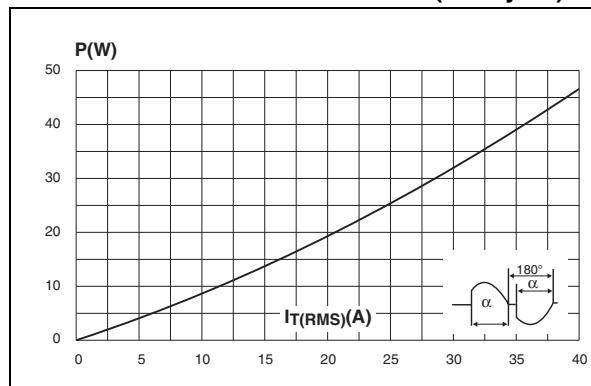
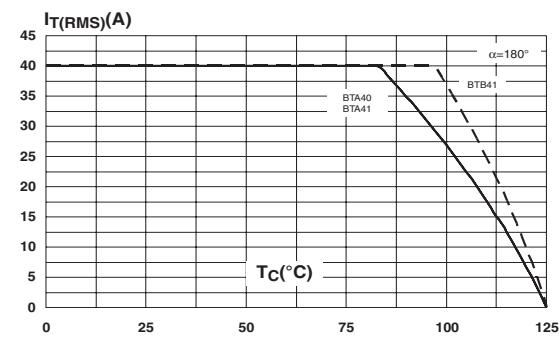
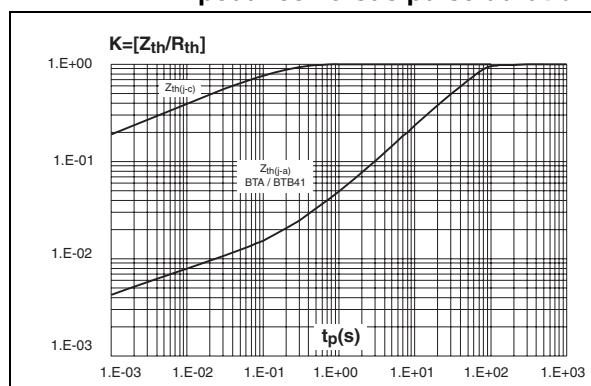
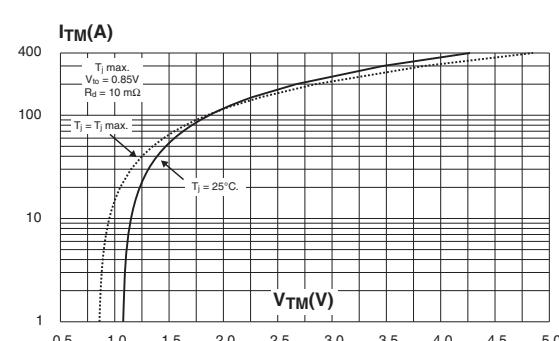
Figure 1. Maximum power dissipation versus on-state rms current (full cycle)**Figure 2. On-state rms current versus case temperature (full cycle)****Figure 3. Relative variation of thermal impedance versus pulse duration****Figure 4. On-state characteristics (maximum values)**

Figure 5. Surge peak on-state current versus number of cycles

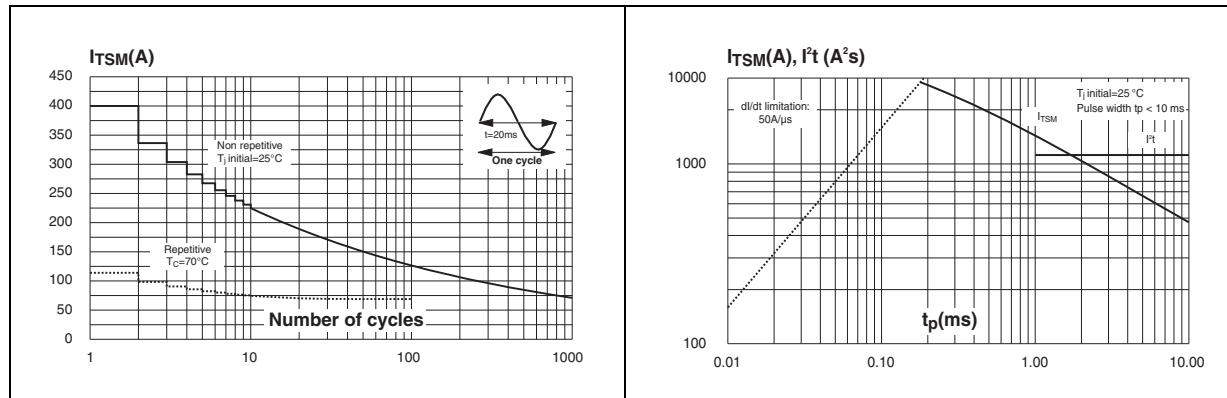


Figure 7. Relative variation of gate trigger, holding and latching current versus junction temperature

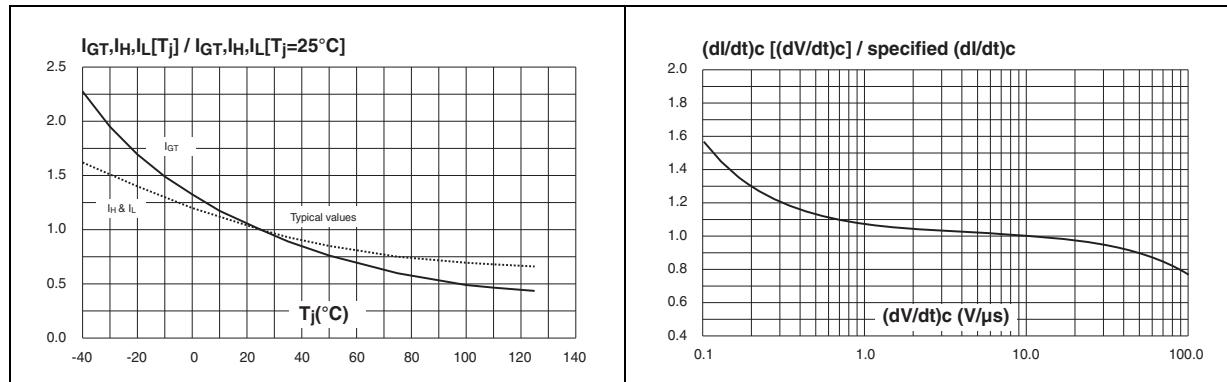


Figure 6. Non-repetitive surge peak on-state current for a sinusoidal pulse and corresponding value of I^2t

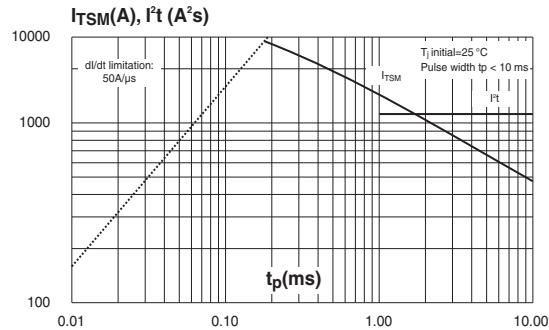
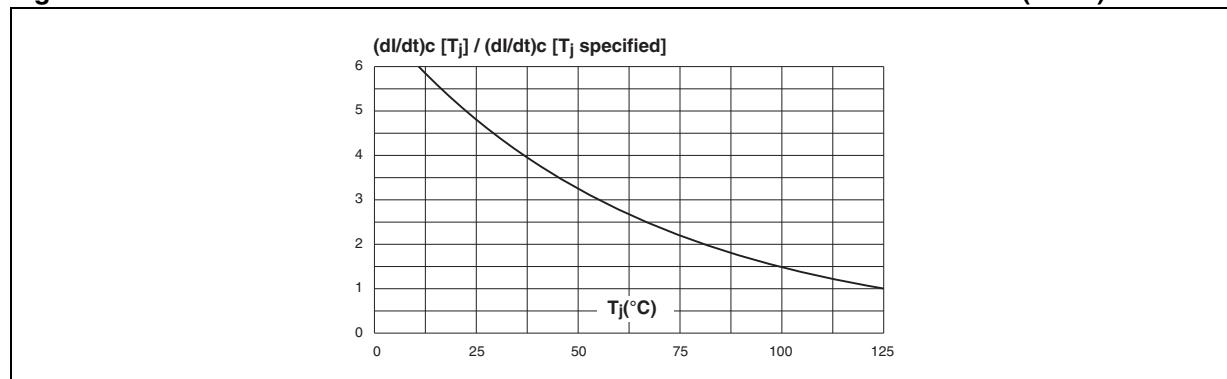
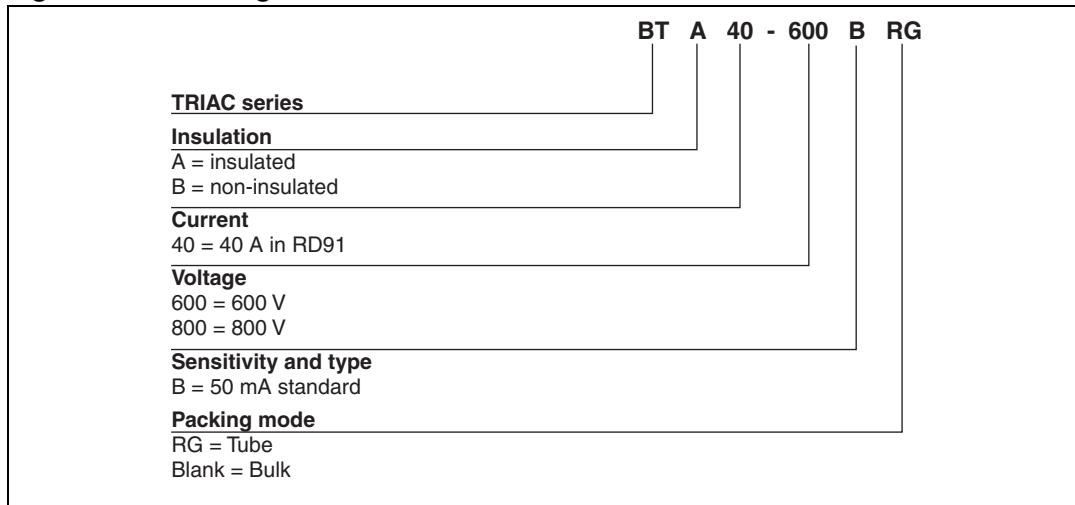


Figure 9. Relative variation of critical rate of decrease of main current versus $(dV/dt)c$



2 Ordering information scheme

Figure 10. Ordering information scheme



3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

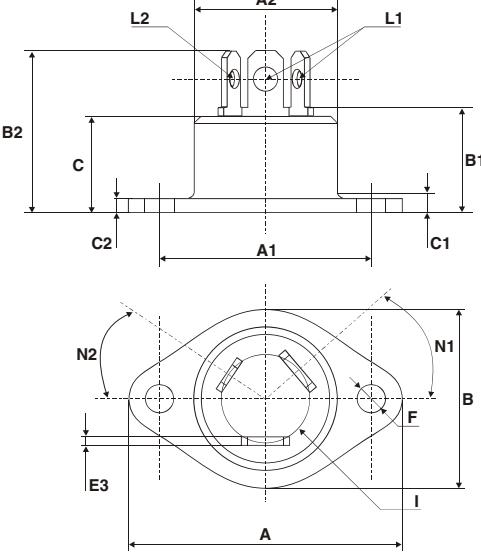
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
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Table 6. TOP3 insulated and non-insulated dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.4	4.6	0.173	0.181
B	1.45	1.55	0.057	0.061
C	14.35	15.60	0.565	0.614
D	0.5	0.7	0.020	0.028
E	2.7	2.9	0.106	0.114
F	15.8	16.5	0.622	0.650
G	20.4	21.1	0.815	0.831
H	15.1	15.5	0.594	0.610
J	5.4	5.65	0.213	0.222
K	3.4	3.65	0.134	0.144
ØL	4.08	4.17	0.161	0.164
P	1.20	1.40	0.047	0.055
R	4.60 typ.		0.181 typ.	

Table 7. RD91 dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	-	40.00	-	1.575
A1	29.90	30.30	1.177	1.193
A2	-	22.00	-	0.867
B	-	27.00	-	1.063
B1	13.50	16.50	0.531	0.650
B2	-	24.00	-	0.945
C	-	14.00	-	0.551
C1	-	3.50	-	0.138
C2	1.95	3.00	0.077	0.118
E3	0.70	0.90	0.027	0.035
F	4.00	4.50	0.157	0.177
I	11.20	13.60	0.441	0.535
L1	3.10	3.50	0.122	0.138
L2	1.70	1.90	0.067	0.075
N1	33°	43°	33°	43°
N2	28°	38°	28°	38°



The technical drawing illustrates the RD91 package in two views: a top view showing the lead frame and bond wires, and a bottom view showing the chip and bond pads. Key dimensions labeled include: A (total width), A1 (width of the chip area), A2 (width of the bond pads), B (total height), B1 (height of the chip area), B2 (height of the bond pads), C (width of the lead frame), C1 (width of the lead frame at the base), C2 (width of the lead frame at the top), E3 (width of the lead frame at the base), F (width of the lead frame at the top), I (length of the lead frame), L1 (width of the lead frame at the top), L2 (width of the lead frame at the base), N1 (angle of the lead frame at the top), and N2 (angle of the lead frame at the base). The top view also shows bond wires labeled L1 and L2 extending from the bond pads.

4 Ordering information

Table 8. Ordering information

Order code ⁽¹⁾	Marking	Package	Weight	Base qty	Delivery mode
BTA40-xxxB	BTA40xxxB	RD91	20 g	25	Bulk
BTA41-xxxBRG	BTA41xxxB	TOP3 Ins.	4.5 g	30	Tube
BTB41-xxxBRG	BTB41xxxB	TOP3	4.5 g	30	Tube

1. xxx = voltage

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
Sep-2003	5	Last update.
25-Mar-2005	6	TOP3 delivery mode changed from bulk to tube.
14-Oct-2005	7	T_c values for I_T changed in Table 3. ECOPACK statement added.
10-Aug-2009	8	Updated Table 2 to correctly place packages. Updated Figure 2 . Table 5 changed to correctly place TOP3. Updated ECOPACK statement.

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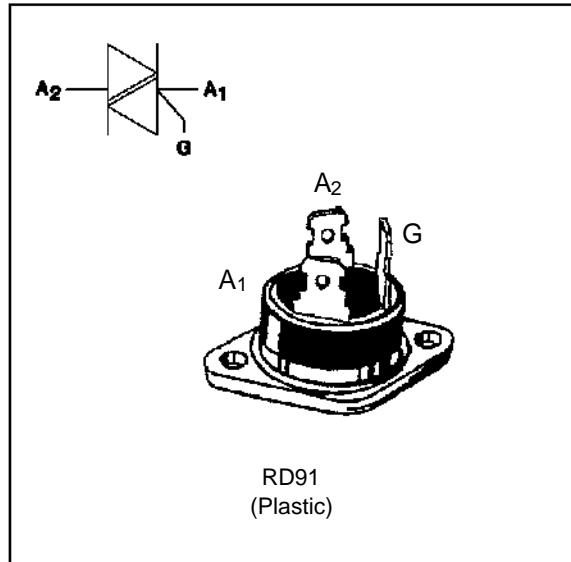
STANDARD TRIACS

FEATURES

- HIGH SURGE CURRENT CAPABILITY
- COMMUTATION : $(dV/dt)c > 10V/\mu s$
- BTA Family :
- INSULATING VOLTAGE = 2500V(RMS)
- (UL RECOGNIZED : E81734)

DESCRIPTION

The BTA40 A/B triac family are high performance glass passivated PNPN devices.
These parts are suitable for general purpose applications where high surge current capability is required. Application such as phase control and static switching on inductive or resistive load.



ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value	Unit
I _T (RMS)	RMS on-state current (360° conduction angle)	40	A
I _{TSM}	Non repetitive surge peak on-state current (T _j initial = 25°C)	tp = 8.3 ms	315
		tp = 10 ms	300
I _{2t}	I _{2t} value	450	A _{2s}
dI/dt	Critical rate of rise of on-state current Gate supply : I _G = 500mA diG/dt = 1A/μs	Repetitive F = 50 Hz	10
		Non Repetitive	50
T _{stg} T _j	Storage and operating junction temperature range	- 40 to + 150 - 40 to + 125	°C °C
T _I	Maximum lead temperature for soldering during 10 s at 4.5 mm from case	260	°C

Symbol	Parameter	BTA40... A/B				Unit
		400	600	700	800	
V _{DRM} V _{RRM}	Repetitive peak off-state voltage T _j = 125 °C	400	600	700	800	V

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th} (j-c) DC	Junction to case for DC	1.2	°C/W
R _{th} (j-c) AC	Junction to case for 360° conduction angle (F= 50 Hz)	0.9	°C/W

GATE CHARACTERISTICS (maximum values)

P_G (AV) = 1W P_{GM} = 40W (tp = 20 μs) I_{GM} = 8A (tp = 20 μs) V_{GM} = 16V (tp = 20 μs).

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions	Quadrant	Suffix		Unit
			A	B	
I _{GT}	V _D =12V (DC) R _L =33Ω	T _j =25°C	I-II-III	MAX	100
			IV	MAX	50
V _{GT}	V _D =12V (DC) R _L =33Ω	T _j =25°C	I-II-III-IV	MAX	150
V _{GD}	V _D =V _{DRM} R _L =3.3kΩ	T _j =125°C	I-II-III-IV	MIN	100
t _{GT}	V _D =V _{DRM} I _G = 500mA dI _G /dt = 3A/μs	T _j =25°C	I-II-III-IV	TYP	2.5
I _L	I _G =1.2 I _{GT}	T _j =25°C	I-III-IV	TYP	70
			II		60
I _H *	I _T = 500mA gate open	T _j =25°C		MAX	200
					180
V _{TM} *	I _{TM} = 60A tp= 380μs	T _j =25°C		MAX	1.8
I _{DRM} I _{RRM}	V _{DRM} Rated V _{RRM} Rated	T _j =25°C		MAX	0.01
				MAX	6
dV/dt *	Linear slope up to V _D =67%V _{DRM} gate open	T _j =125°C		MIN	250
(dV/dt) _C *	(dI/dt) _C = 18A/ms	T _j =125°C		MIN	10
					V/μs

* For either polarity of electrode A2 voltage with reference to electrode A1.

ORDERING INFORMATION

Package	$I_T(\text{RMS})$	V_{DRM} / V_{RRM}	Sensitivity Specification	
			A	B
BTA (Insulated)	40	400	X	X
		600	X	X
		700	X	X
		800	X	X

Fig.1 : Maximum RMS power dissipation versus RMS on-state current ($F=50\text{Hz}$).
(Curves are cut off by $(dl/dt)_c$ limitation)

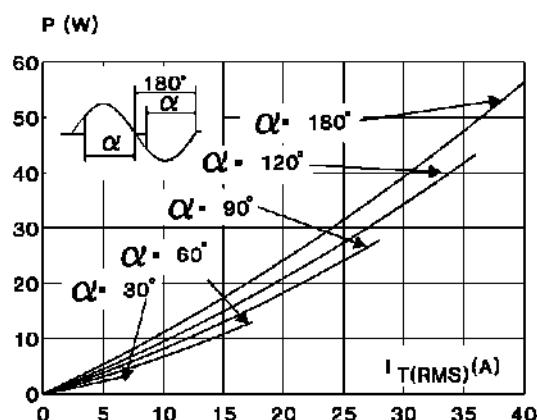


Fig.3 : RMS on-state current versus case temperature.

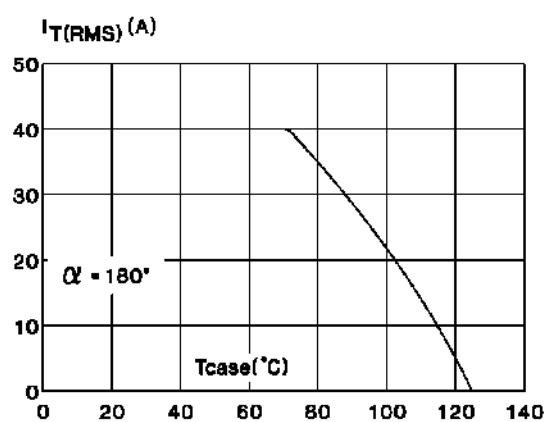


Fig.2 : Correlation between maximum RMS power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact.

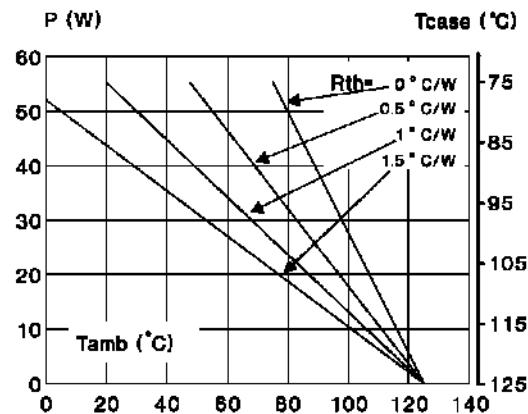
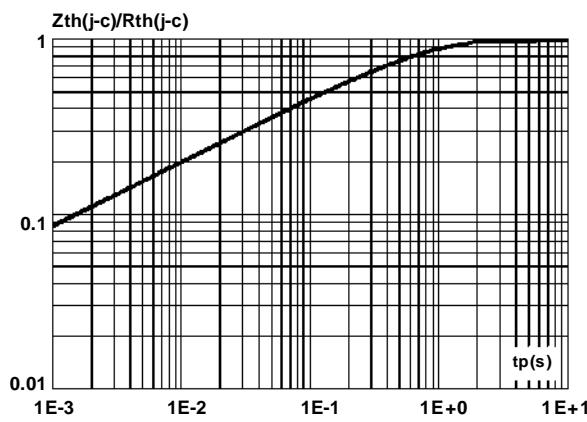


Fig.4 : relative variation of thermal impedance junction to case versus pulse duration.



BTA40 A/B

Fig.5 : Relative variation of gate trigger current and holding current versus junction temperature.

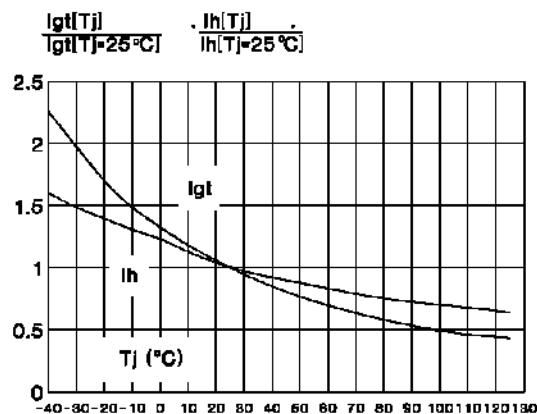


Fig.7 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10\text{ms}$, and corresponding value of I^2t .

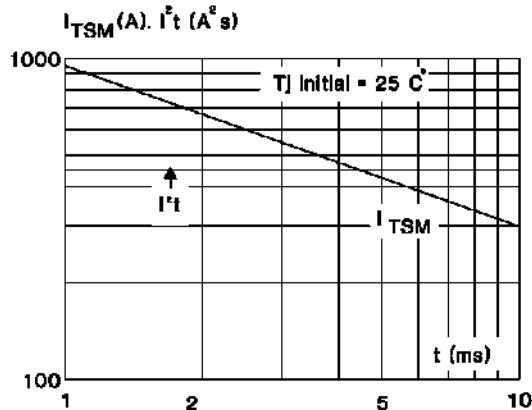


Fig.6 : Non Repetitive surge peak on-state current versus number of cycles.

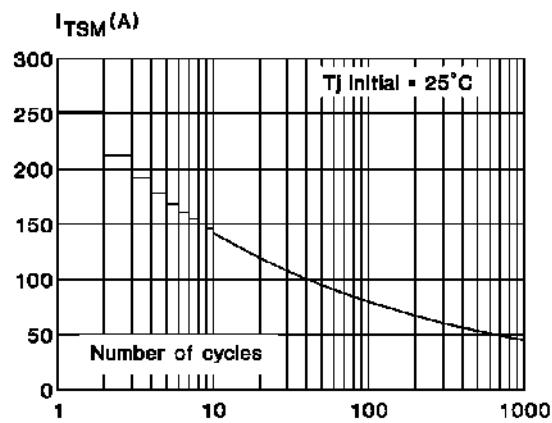
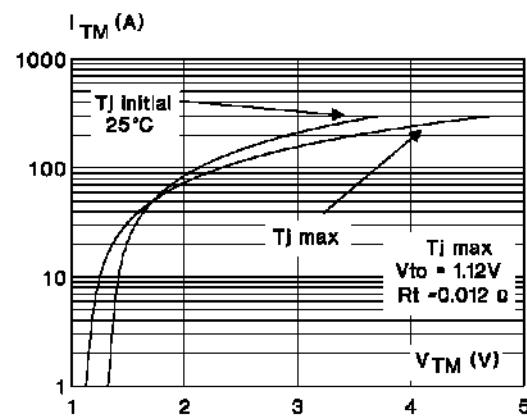
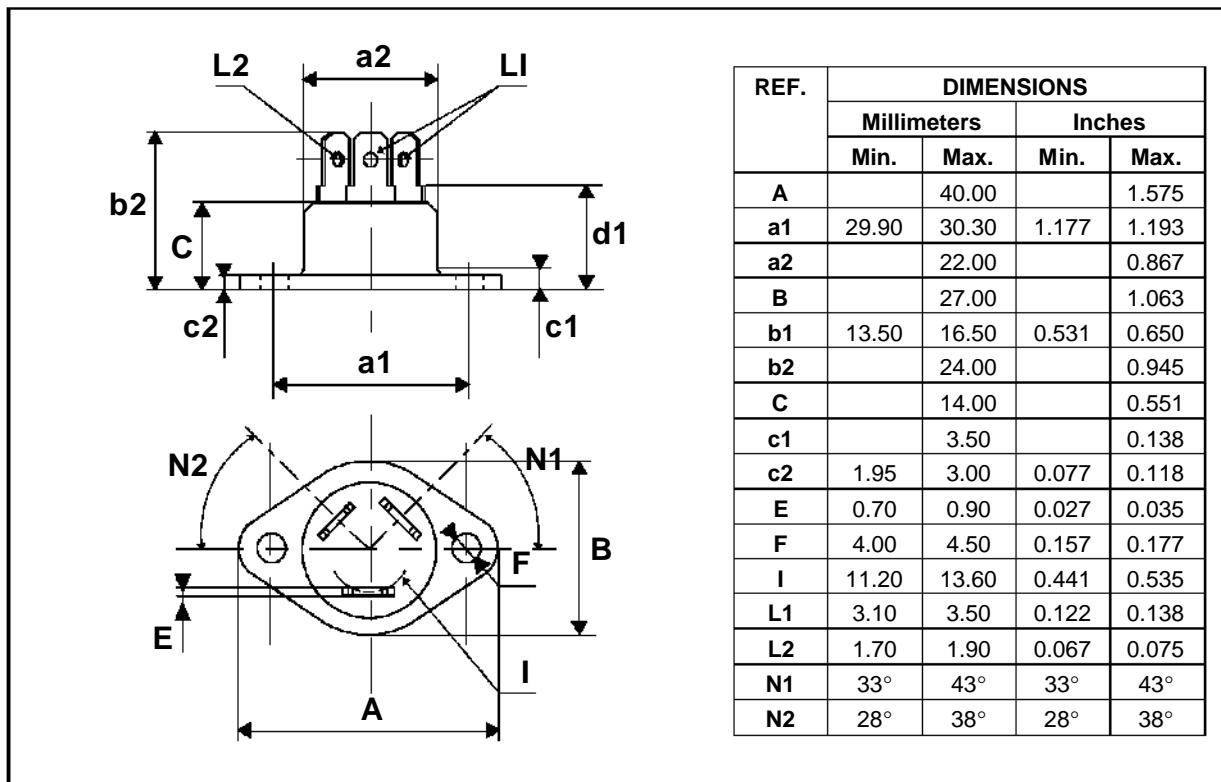


Fig.8 : On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA

RD91 Plastic



Marking : type number

Weight : 20 g

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